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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Todd O. Bolken

Serial No.: 09/516,080

Filed: March 1, 2000

For: EXPOSED DIE MOLDING  
APPARATUS§  
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Group Art Unit: 2814

Examiner: Louie, Wai Sing

Atty. Docket: MICS:0043 FLE/MAN  
99-0634Mail Stop Non-Fee Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313CERTIFICATE OF TRANSMISSION OR MAILING  
37 C.F.R. 1.8

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July 23, 2003

Date

  
Michael G. Fletcher

Sir:

**RESPONSE**

In response to the Official Action mailed on April 23, 2003, Applicant respectfully requests reconsideration of the above-identified application in light of the remarks set forth below.

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